

Microwave Coaxial Connectors



muRata

*Innovator
in Electronics*

Murata
Manufacturing Co., Ltd.

Cat.No.O30E-8

for EU RoHS Compliant

- All the products on this catalog are complied with EU RoHS.
- EU RoHS is "the European Directive 2002/95/EC on the Restriction of the Use of Certain Hazardous Substances in Electrical and Electronic Equipment".
- For more details, please refer to our website 'Murata's Approach for EU RoHS' (<http://www.murata.com/info/rohs.html>).

CONTENTS

Part Numbering	2
1 Microwave Coaxial Connectors with Switch SWF Type	3
● Notice	5
● Package	8
2 Microwave Coaxial Connectors with Switch SWD Type	9
● Notice	11
● Package	14
3 Ultra Miniature SMT HSC Type	15
● Notice	18
● Package	21
4 Miniature SMT GSC Type	22
● Notice	25
● Package	28
5 SMT FSC Type	29
● Notice	32
● Package	35
Miniaturized Microwave Coaxial Connector Cable List	36

● Part Numbering

Coaxial Connectors (Chip Type Receptacle)

(Part Number)

MM	7329	-27	00	R	A1
----	------	-----	----	---	----

 ① ② ③ ④ ⑤ ⑥

① Product ID

Product ID	
MM	Microwave Coaxial Connectors (Chip Type Receptacle)

② Series

Code	Series
4829	HSC Type
7329	FSC Type
8130	SWF Type
8430	SWD Type
9329	GSC Type

③ Individual Specification Code (1)

Code	Individual Specification Code (1)
-26	Switch Connector SMD Type
-27	Connector SMD Type

④ Individual Specification Code (2)

Code	Individual Specification Code (2)
00	Serial

⑤ Package Product ID

Code	Package Product ID
B	Bulk
R	Reel

⑥ Package Detail

Code	Package Detail
A1	FSC, SWD, GSC Type 1000pcs. /Reel (ø178mm)
A4	HSC Type, 4000pcs. /Reel (ø178mm)
B0	HSC Type, 10000pcs. /Reel (ø330mm)
B3	SWD Type, 3000pcs. /Reel (ø330mm)
B4	FSC Type, 4000pcs. /Reel (ø330mm)
B5	GSC Type, 5000pcs. /Reel (ø330mm)
B8	SWF Type, 8000pcs. /Reel (ø330mm)

Coaxial Connectors (with Cable)

(Part Number)

MX	FG	76			
----	----	----	--	--	--

 ① ② ③ ④ ⑤ ⑥

① Product ID

Product ID	
MX	Coaxial Connectors (with Cable)

② Connector (1)

Code	Connector (1)
FG	FSC Type for 76 Cable
FK	FSC Type for 81 Cable
HP	HSC Type
TK	GSC Type

③ Cable

Code	Cable
32	0.4D, PFA, Single Shield Line, Spiral
76	0.8D, FEP, Single Shield Line
81	0.4D, FEP, Single Shield Line
88	0.4D, PFA, Single Shield Line, Single Line
92	0.4D, PFA, Single Shield Line, Spiral

④ Connector (2)

Code	Connector (2)
FG	FSC Type for 76 Cable
FK	FSC Type for 81 Cable
HP	HSC Type
TK	GSC Type
XX	None Connector

⑤ Length

Expressed by four figures. The unit is mm. From first to third figures are significant, and the fourth figure expresses the number of zeros which follow the three figures.

Ex.)	Code	Length
	5000	500mm = 500 x 10 ⁰
	1001	1000mm = 100 x 10 ¹

⑥ Individual Specification Code

Expressed by two sign.

muRata

1

■ Measurement Probe Dimensions

■ Structure

[illegible]

Standard Solder Stencil Mask Pattern
(Mask thickness 0.12mm)

(in mm)

■ Notice (Storage and Operating Condition)

1. Environment Conditions

- (1) This product is designed for use in electrical equipment in the environment (temperature, humidity, atmospheric pressure, etc.) specified in this approval drawing. It may not be used in the following environments or under the following conditions:
 - (a) Ambient air containing corrosive gas (Chlorine gas, Hydrogen sulfide gas, Ammonia gas, Sulfuric acid gas, Nitric oxide gas, etc.)
 - (b) Ambient air containing volatile or combustible gas
 - (c) In liquid (water, oil, chemical solution, organic solvents, etc.)
 - (d) In environments with a high concentration of airborne particles
 - (e) In direct sunlight
 - (f) Dusty conditions
 - (g) In freezing
 - (h) Other environments similar to the above conditions
- (2) Contact the manufacturer before using the product in any of the above environments or under any of the above conditions.

2. Storage

Store in manufacturer's package or tightly re-closed box with the following conditions. Use this product within 6 months after receipt. Check the terminal solderability before use if the product has been stored for more than 6 months.
Temperature: -10 to +40 degree C
Humidity: 15 to 85% RH

Notice

■ Notice (Soldering and Mounting)

1. Reflow soldering

Soldering must be carried out without exceeding the allowable soldering temperature and time shown within the shaded area of Figure "Allowable Temperature and Time of Reflow Soldering".

In case the soldering is repeated, the maximum time in Figure "Allowable Temperature and Time of Reflow Soldering" should be accumulated time. The standard soldering conditions are shown in Figure "Reflow Soldering Standard Conditions".

Follow standard solder stencil mask pattern to avoid the possibility of solder being trapped under connector.

2. Soldering by soldering iron

Soldering by soldering iron should be carried out in accordance to the following conditions.

Pre-heating	Temperature	150°C
	Time	60 to 120 s.
Soldering	Temperature (at the tip of the soldering iron)	less than 350°C
	Time	less than 3 s.

3. We cannot warrant against mishaps caused by any use of this product that deviates from allowable temperature and time of reflow soldering.

4. In soldering, do not apply excessive mechanical force to terminals or leads greater than specified in the drawing.

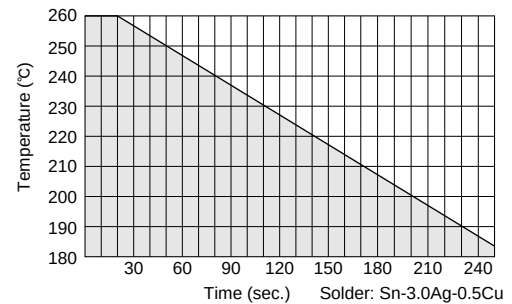
5. Please note the following in case of soldering terminals or leads of the product.

- (1) Use Rosin based flux, but not with strong acid flux (Chlorine content should be less than 0.20wt%).
- (2) Flux should be thoroughly cleaned from connector to prevent possible deterioration of electrical characteristics.

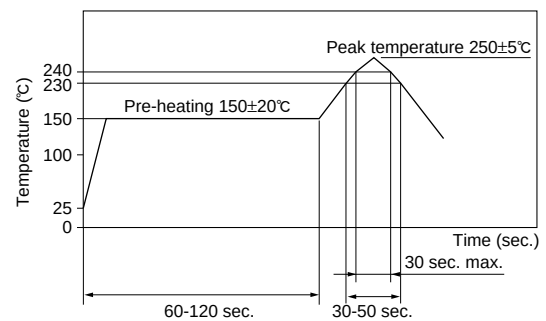
6. Please mount this product at the position so that stress by wrap and/or bend of the PCB may not apply to it.

7. Please avoid the cleaning of this product.

Allowable Temperature and Time of Reflow Soldering



Reflow Soldering Standard Conditions



Measuring point of temperature: In-Out Terminals of the Device
 Reflow Soldering: Both Convection and Infrared Rays
 : Hot Air
 : Hot Plate

Continued on the following page. ↗

Notice

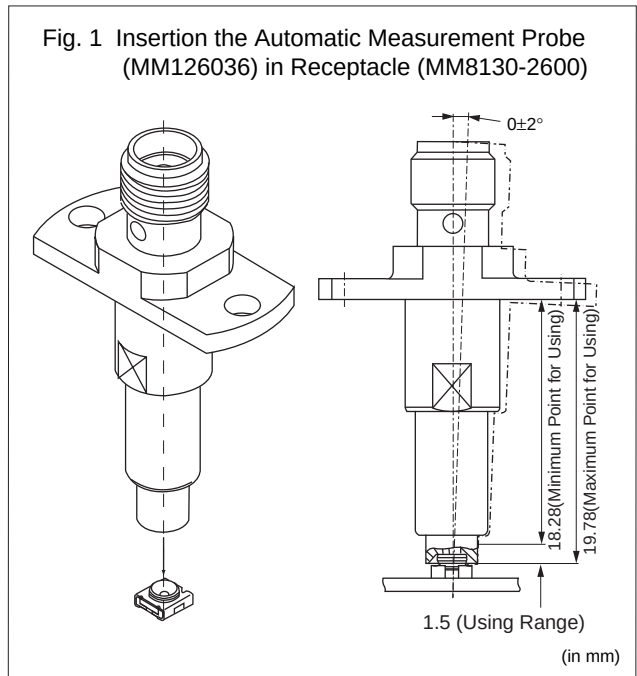
1

Continued from the preceding page.

■ Notice(Handling)

1. Automatic Measurement Probe (MM126036)

- Automatic measurement probe (MM126036) should be used on the condition in Fig. 1 for good connection without any damages.
- The engagement strokes from the flange to the tip of probe is 18.28mm to 19.78mm with vertical (0 ± 2 degree) direction.

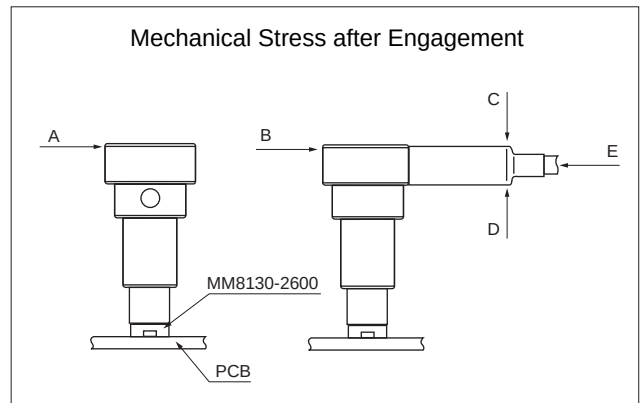


2. L Type Probe with Locking Function (MXHS83QE3000, MXHS83QH3000)

- Do not try to pull the cable, when a connector with a coaxial cable is handled.
- Do not give a twisted torque to the cable and connector.
- Mechanical stress:

The stress to the connector should be limited as figure shown right.

- (1) Stress to the housing.
Stress A and B: 0.5N max.
- (2) Stress to the outer sleeve.
Stress C: 0.6N max.
Stress D: 0.6N max.
- (3) Cable pull strength.
Stress E: 0.5N max.



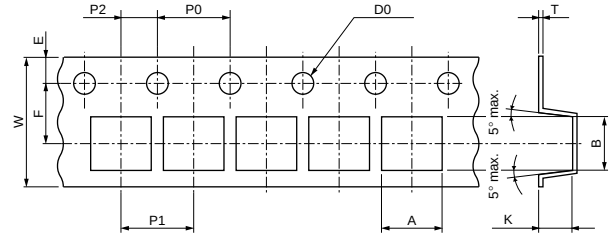
3. Usage Condition

- (1) Do not apply electrical voltage greater than specified in the catalog. It might cause degradation or destruction of the product. Even if it endures during a short time, long time qualification is not guaranteed.
- (2) Confirm that product performance is not influenced with any other components or materials which directly contact products.

4. Handling

Do not apply excessive shock or load to subassembly products such as soldered printed circuit board in case handling or transporting.

■ Dimensions of Taping



P0	P1	P2	T
4±0.1	4±0.1	2±0.1	0.25±0.05

(in mm)

MM8130-2600B: Bulk/free

muRata

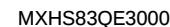
2

MM8430-2610



Impedance: 50ohm

MM126036



■ Structure

Technical drawing of the SMA-J connector assembly. The drawing shows a side view of the assembly with various dimensions and labels.

Dimensions:

- Overall length: 300 ± 4
- Distance from the end of the cable to the center of the SMA-J connector: (26)
- Distance from the end of the cable to the center of the SMA-J connector (indicated by a dashed line): (32)
- Overall height: 20.1 ± 0.2
- Height of the SMA-J connector: 13.9 ± 0.2
- Height of the SMA-J connector (indicated by a dashed line): 12 ± 0.2
- Height of the SMA-J connector (indicated by a dashed line): 3.1 ± 0.1

Labels:

- 0.8D Cable
- SMA-J

Dimensions for the SMA-J connector:

- Dia. 3.2 ± 0.1
- Dia. 3.4 ± 0.1
- Dia. 4.3 ± 0.1
- Dia. 5.8 ± 0.2

The diagram illustrates the effect of a probe on a quantum state. It is divided into two parts: "Without Probe" and "With Probe".

Without Probe: A step function is shown. The horizontal axis is labeled "OUT" on the left and "IN" on the right. A single downward arrow labeled "Probe" points to the step function.

With Probe: A similar step function is shown. The horizontal axis is labeled "OUT" on the left and "IN" on the right. Two downward arrows labeled "Probe" point to the step function, indicating a second measurement.

Figure 1 is a schematic diagram of a four-electrode probe. The diagram shows a cross-section of the probe with four electrodes (light gray) and four lands (dark gray). Dimensions are given in mm: total width 4, electrode width 2, land width 1, gap between electrodes 0.5, total height 4.1, electrode height 3.1, land height 2.1, gap between lands 1, total width of the probe body 3, electrode width 1.5, and gap between electrodes 1.74. A 'Through hole' is indicated in the center of the probe body.

The Standard solder stencil mask pattern
(Mask thickness 0.15mm)

(in mm)

Notice

■ Notice (Storage and Operating Condition)

1. Environment Conditions

- (1) This product is designed for use in electrical equipment in the environment (temperature, humidity, atmospheric pressure, etc.) specified in this approval drawing. It may not be used in the following environments or under the following conditions:
 - (a) Ambient air containing corrosive gas (Chlorine gas, Hydrogen sulfide gas, Ammonia gas, Sulfuric acid gas, Nitric oxide gas, etc.)
 - (b) Ambient air containing volatile or combustible gas
 - (c) In liquid (water, oil, chemical solution, organic solvents, etc.)
 - (d) In environments with a high concentration of airborne particles
 - (e) In direct sunlight
 - (f) Dusty conditions
 - (g) In freezing
 - (h) Other environments similar to the above conditions
- (2) Contact the manufacturer before using the product in any of the above environments or under any of the above conditions.

2. Storage

Store in manufacturer's package or tightly re-closed box with the following conditions. Use this product within 6 months after receipt. Check the terminal solderability before use if the product has been stored for more than 6 months.
Temperature: -10 to +40 degree C
Humidity: 15 to 85% RH

Notice

■ Notice (Soldering and Mounting)

1. Reflow soldering

Soldering must be carried out without exceeding the allowable soldering temperature and time shown within the shaded area of Figure "Allowable Temperature and Time of Reflow Soldering".

In case the soldering is repeated, the maximum time in Figure "Allowable Temperature and Time of Reflow Soldering" should be accumulated time. The standard soldering conditions are shown in Figure "Reflow Soldering Standard Conditions".

Follow standard solder stencil mask pattern to avoid the possibility of solder being trapped under connector.

2. Soldering by soldering iron

Soldering by soldering iron should be carried out in accordance to the following conditions.

Pre-heating	Temperature	150°C
	Time	60 to 120 s.
Soldering	Temperature (at the tip of the soldering iron)	less than 350°C
	Time	less than 3 s.

3. We cannot warrant against mishaps caused by any use of this product that deviates from allowable temperature and time of reflow soldering.

4. In soldering, do not apply excessive mechanical force to terminals or leads greater than specified in the drawing.

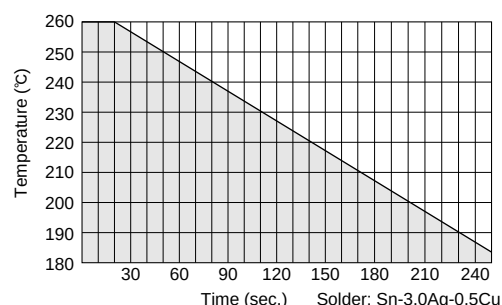
5. Please note the following in case of soldering terminals or leads of the product.

- (1) Use Rosin based flux, but not with strong acid flux (Chlorine content should be less than 0.20wt%).
- (2) Flux should be thoroughly cleaned from connector to prevent possible deterioration of electrical characteristics.

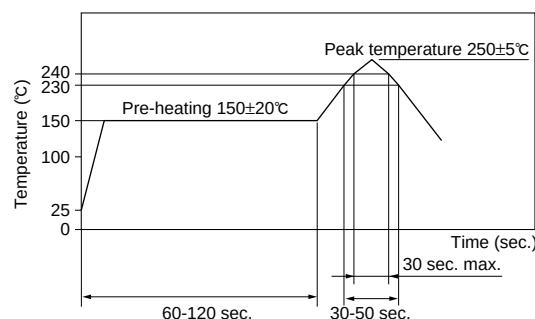
6. Please mount this product at the position so that stress by wrap and/or bend of the PCB may not apply to it.

7. Please avoid the cleaning of this product.

Allowable Temperature and Time of Reflow Soldering



Reflow Soldering Standard Conditions



Measuring point of temperature: In-Out Terminals of the Device
 Reflow Soldering: Both Convection and Infrared Rays
 : Hot Air
 : Hot Plate

Continued on the following page. ↗

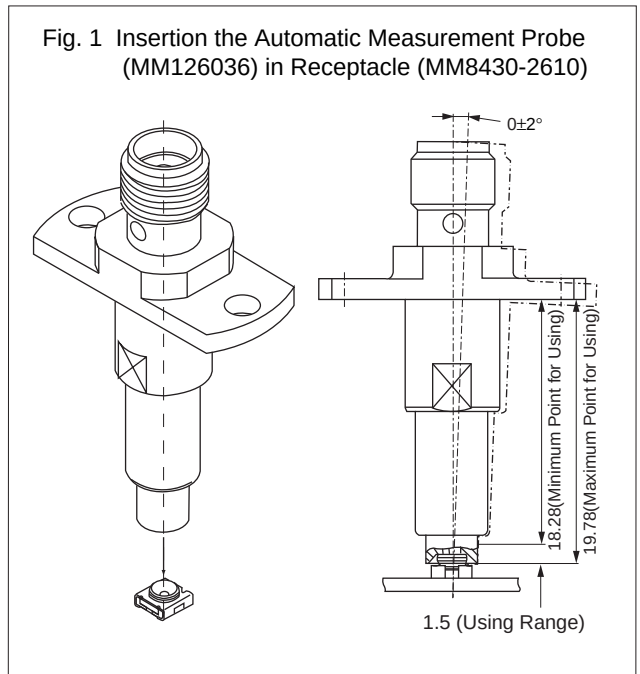
Notice

Continued from the preceding page.

■ Notice (Handling)

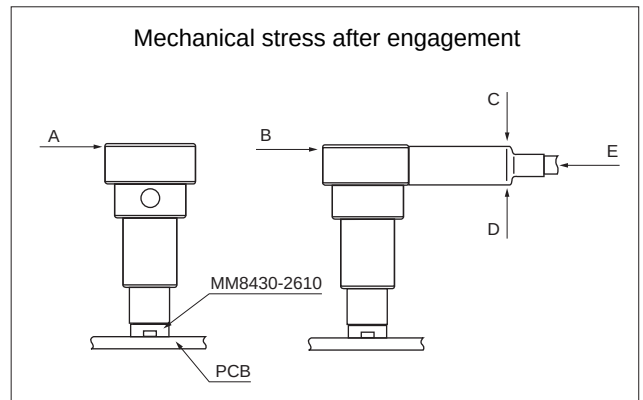
1. Automatic Measurement Probe (MM126036)

- Automatic measurement probe (MM126036) should be used under conditions in Fig. 1 for good connection without any damages.
- The engagement strokes from the flange to the tip of probe is 18.28mm to 19.78mm with vertical ($0\pm2^\circ$) direction.



2. L Type Probe with Locking Function (MXHS83QE3000, MXHS83QH3000)

- Avoid pulling cable when probe is locked into connector.
 - Avoid twisting probe or cable when engaging or disengaging from connector.
 - Mechanical stress:
The stress to the connector should be limited as figure shown right.
- (1) Stress to the housing.
Stress A and B: 0.5N max.
 - (2) Stress to the outer sleeve.
Stress C: 0.6N max.
Stress D: 0.6N max.
 - (3) Cable pull strength.
Stress E: 0.5N max.



3. Usage Condition

- (1) Do not apply electrical voltage greater than specified in the catalog. It might cause degradation or destruction of the product. Even if it endures during a short time, long time qualification is not guaranteed.
- (2) Confirm that product performance is not influenced with any other components or materials which directly contact products.

4. Handling

Avoid excessive stress when handling and transporting printed circuit board after connector and/or assembly has been secured to PCB.

■ Dimensions of Reel



Technical drawing of a 3D printed part showing dimensions and tolerances. The drawing includes a side view and a cross-sectional view. Dimensions are labeled as follows:

- P2**: Distance from the left edge to the first hole.
- P0**: Distance between the first and second holes.
- D0**: Diameter of the holes.
- P1**: Distance from the left edge to the center of the first rectangular feature.
- A**: Distance from the center of the first rectangular feature to the center of the second rectangular feature.
- W**: Width of the part.
- E**: Thickness of the part.
- W**: Width of the part (repeated).
- T**: Thickness of the top flange.
- B**: Width of the bottom flange.
- K**: Distance from the bottom edge to the center of the bottom flange.
- 3 degree Max.**: Fillet radius specification.

(in mm)

P0	P1	P2	T
4±0.1	8±0.1	2±0.1	0.3±0.05

muRata

muRata

3

Technical drawing of the MXHP package. The drawing includes a perspective view of the package and three cross-sectional views. The dimensions are as follows:

- Top view: 2.06
- Side view: 0.85
- Bottom view: (2.1 dia.), 2.34±0.5

MXHP

(in mm)

Technical drawing of the MM4829-2702 component, showing three views: top, side, and cross-sectional views.

Top View Dimensions:

- Overall width: 2
- Overall height: 2
- Inner diameter: 0.8 Dia.

Side View Dimensions:

- Overall width: 1.52
- Overall height: 1.4
- Top flange width: 0.7
- Top flange thickness: 0.4
- Bottom flange thickness: 0.5

Cross-sectional View Dimensions:

- Overall width: 1.52
- Overall height: 0.6
- Inner diameter: 1.5 Dia.

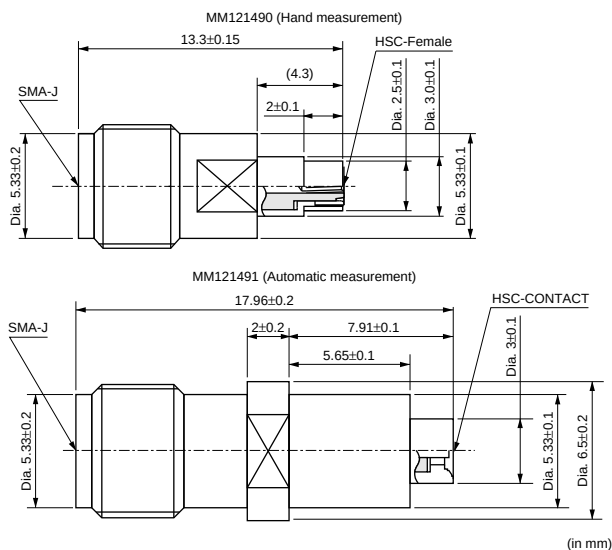
Legend:

- Hot Terminal (Shaded area)
- Ground Terminal (Unshaded area)

Tolerances: Unless Otherwise Specified: ± 0.2 (in mm)

Part Number: MM4829-2702

Impedance: 50ohm

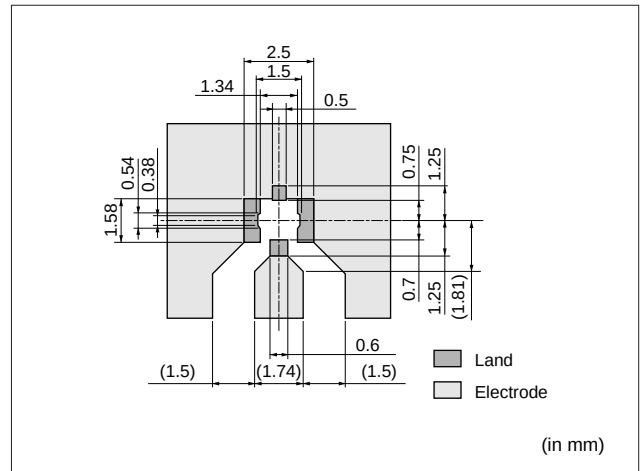


 Continued from the preceding page.

■ Land Pattern Dimensions

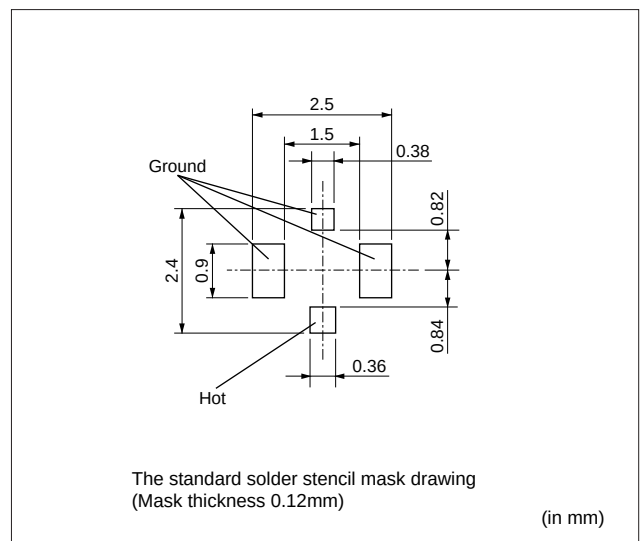
1. Standard pattern dimensions

- I/O pattern should be designed to match 50 ohm impedance circuit.
- Typical PCB material is glass epoxy ($\epsilon_r=4.8$). Thickness is 1.0mm.
- The solder resist should be printed except for the land pattern on the PCB.



2. Standard solder stencil mask pattern

Follow Standard solder stencil mask pattern to avoid the possibility of solder being trapped under connector.



Notice

■ Notice (Storage and Operation Condition)

1. Environment Conditions

- (1) This product is designed for use in electrical equipment in the environment (temperature, humidity, atmospheric pressure, etc.) specified in this approval drawing. It may not be used in the following environments or under the following conditions:
- (a) Ambient air containing corrosive gas (Chlorine gas, Hydrogen sulfide gas, Ammonia gas, Sulfuric acid gas, Nitric oxide gas, etc.)
 - (b) Ambient air containing volatile or combustible gas
 - (c) In liquid (water, oil, chemical solution, organic solvents, etc.)
 - (d) In environments with a high concentration of airborne particles
 - (e) In direct sunlight
 - (f) Dusty conditions
 - (g) In freezing
 - (h) Other environments similar to the above conditions
- (2) Contact the manufacturer before using the product in any of the above environments or under any of the above conditions.

2. Storage

Store in manufacturer's package or tightly re-closed box with the following conditions. Use this product within 6 months after receipt. Check the terminal solderability before use if the product has been stored for more than 6 months.

Temperature: -10 to +40 degree C
Humidity: 15 to 85% RH

Notice

■ Notice (Soldering and Mounting)

1. Reflow soldering

Soldering must be carried out without exceeding the allowable soldering temperature and time shown within the shaded area of Figure "Allowable Temperature and Time of Reflow Soldering".

In case the soldering is repeated, the maximum time in Figure "Allowable Temperature and Time of Reflow Soldering" should be accumulated time. The standard soldering conditions are shown in Figure "Reflow Soldering Standard Conditions".

Use the Pattern and Metal mask pattern is illustrated in details.

Follow standard solder stencil mask pattern to avoid the possibility of solder being trapped under connector.

2. Soldering by soldering iron

Soldering by soldering iron should be carried out in accordance to the following conditions.

Pre-heating	Temperature	150°C
	Time	60 to 120 s.
Soldering	Temperature (at the tip of the soldering iron) less than 350°C	
	Time	less than 3 s.

3. We cannot warrant against mishaps caused by any use of this product that deviates from allowable temperature and time of reflow soldering.

4. In soldering, do not apply excessive mechanical force to terminals or leads greater than specified in the drawing.

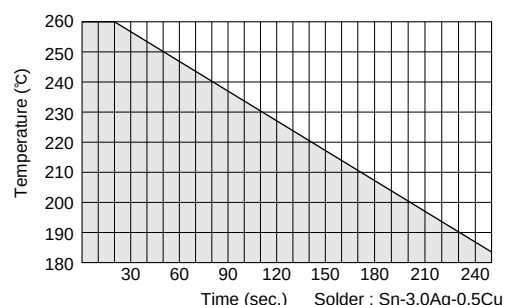
5. Please note the following in case of soldering terminals or leads of the product.

- (1) Use Rosin based flux, but not with strong acid flux (Chlorine content should be less than 0.20wt%).
- (2) Flux should be thoroughly cleaned from connector to prevent possible deterioration of electrical characteristics.

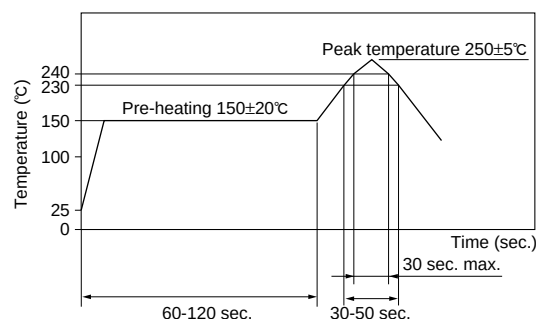
6. Please mount this product at the position so that stress by wrap and/or bend of the PCB may not apply to it.

7. Please dry out this product immediately after soldering and cleaning.

Allowable Temperature and Time of Reflow Soldering



Reflow Soldering Standard Conditions



Measuring point of temperature : In-Out Terminals of the Device
 Reflow Soldering : Both Convection and Infrared Rays
 : Hot Air
 : Hot Plate

Continued on the following page.

Notice

Continued from the preceding page.

■ Notice (Handling)

1. Usage Condition

- (1) Do not apply electrical voltage greater than specified in the drawing. It might cause degradation or destruction of the product. Even if it endures during a short time, long time qualification is not guaranteed.
- (2) Confirm product's performance is not influenced by contact of other components.
- (3) Please contact the manufacturer beforehand, if the product is to be used in frequently bent position.

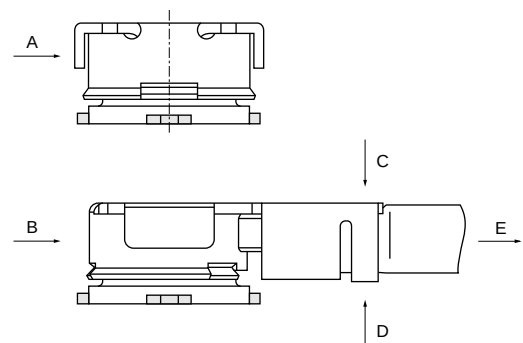
2. Handling

- (1) Avoid excessive stress when handling and transporting printed circuit board after connector and/or assembly has been secured to PCB.
- (2) Do not try to pull the cable, when a connector with a coaxial cable is handled.
- (3) Disregarding the following notes could cause mechanical damage and/or poor electrical performance.

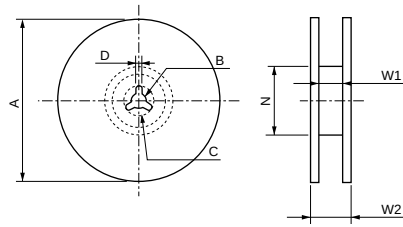
3. Handling Instructions

- (1) Cable is designed to fit only with MM4829-2702 receptacle. Any other receptacle cannot be used with this cable.
- (2) Disengagement:
Use tool P/N M19100 to insert or remove cable in a vertical direction from receptacle. Avoid pulling only the cable to prevent cable damage.
- (3) Avoid twisting probe or cable when engaging or disengaging from connector.
- (4) Mechanical stress:
The stress to the connector should be limited as shown in Figure 1.
 - (a) Stress to the housing.
Stress A and B: 5.0N max.
 - (b) Stress to the outer sleeve.
 - Stress C: 1.0N max.
 - Stress D: 1.0N max.
 - (c) Cable pull strength.
Stress E: 5.0N max.

Figure 1. Mechanical stress after engagement

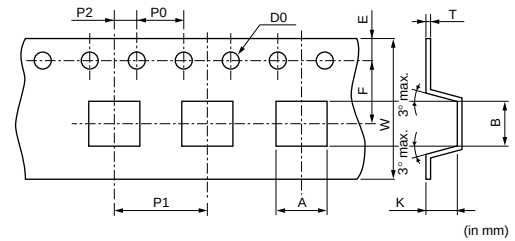


■ Dimensions of Taping



(in mm)

Murata Part Number	A	B	C	D	N (min.)	W1	W2 (max.)
MM4829-2702RA4	180 $\pm$ 0/-3	13	21	2	Dia. 60 $\pm$ 1/0	9 $\pm$ 0.3	11.4
MM4829-2702RB0	330	13	21	2	Dia. 100	9.4	13.4
TOLERANCE	$\pm$ 2.0	$\pm$ 0.2	$\pm$ 0.8	$\pm$ 0.5	$\pm$ 1.0	$\pm$ 1.0	$\pm$ 1.0



(in mm)

A	B	W	D0	E	F	K
2.35±0.1	2.35±0.1	8±0.2	Dia.1.5 ^{+0.1} ₋₀	1.75±0.1	3.5±0.1	0.75±0.15

P0	P1	P2	T
4±0.1	4±0.1	2±0.1	0.25±0.05

■ Minimum Quantity

MM4829-2702RA4: 180 mm dia. reel/4000 pcs.

MM4829-2702RB0: 330 mm dia. reel/10000 pcs.

MM4829-2702B: Bulk/free

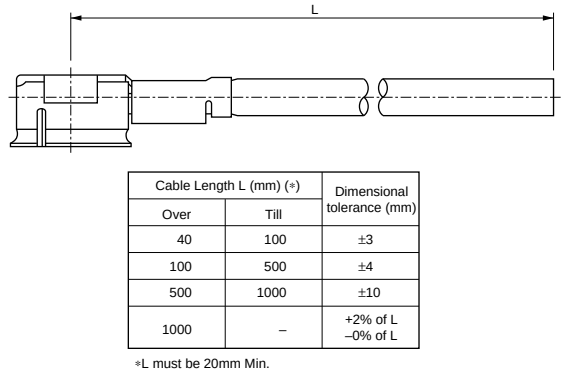
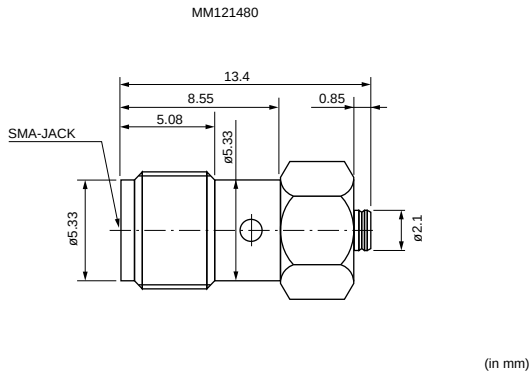
muRata

muRata

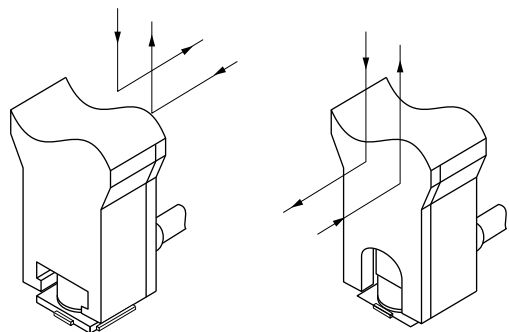
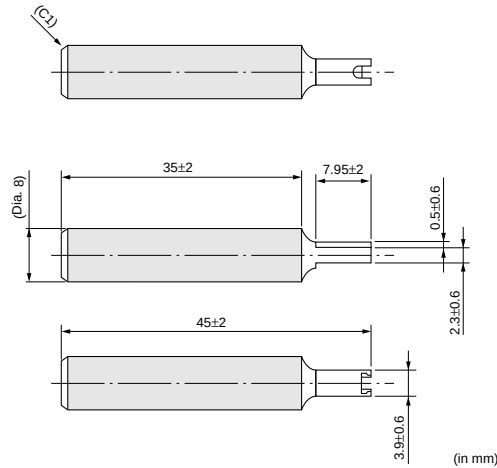
 Continued from the preceding page.

■ Measurement Adapter Dimensions (for Cable Assembly)

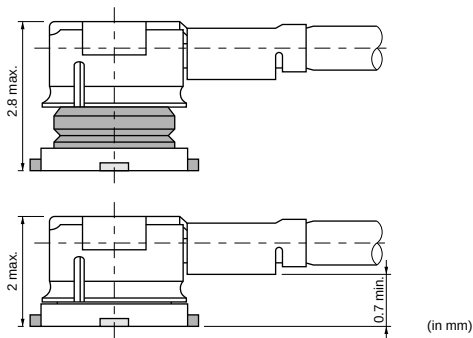
■ Cable Length Tolerance



■ Disengagement Tool (Part Number: M22001)



■ Profile Dimensions



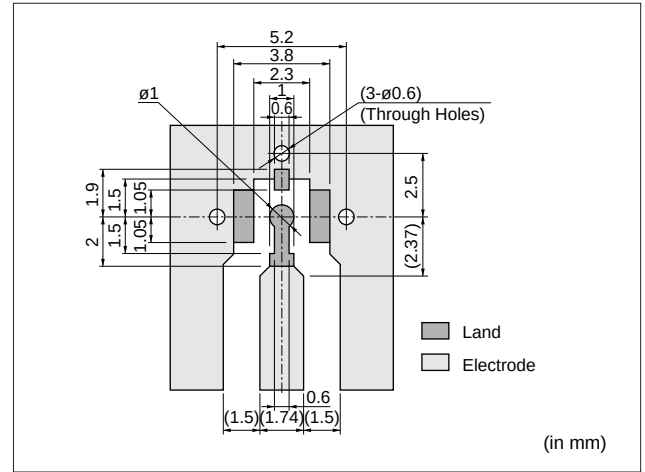
Continued on the following page. 

Continued from the preceding page.

■ Land Pattern Dimensions

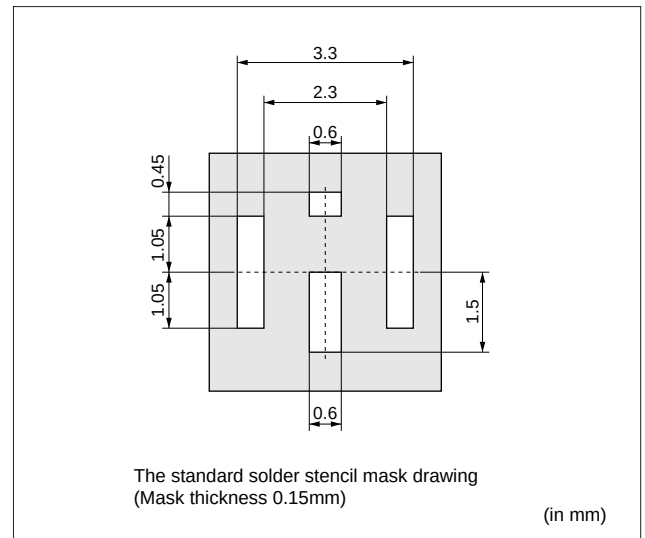
1. Standard pattern dimensions

- I/O pattern should be designed to match 50 ohm impedance circuit.
- Typical PCB material is glass epoxy ($\epsilon_r=4.8$). Thickness is 1.0mm
- The solder resist should be printed except for the land pattern on the PCB.



2. Standard solder stencil mask pattern

Follow Standard solder stencil mask pattern to avoid the possibility of solder being trapped under connector.



Notice

■ Notice (Storage and Operation Condition)

1. Environment Conditions

- (1) This product is designed for use in electrical equipment in the environment (temperature, humidity, atmospheric pressure, etc.) specified in this approval drawing. It may not be used in the following environments or under the following conditions:
 - (a) Ambient air containing corrosive gas (Chlorine gas, Hydrogen sulfide gas, Ammonia gas, Sulfuric acid gas, Nitric oxide gas, etc.)
 - (b) Ambient air containing volatile or combustible gas
 - (c) In liquid (water, oil, chemical solution, organic solvents, etc.)
 - (d) In environments with a high concentration of airborne particles
 - (e) In direct sunlight
 - (f) Dusty conditions
 - (g) In freezing
 - (h) Other environments similar to the above conditions
- (2) Contact the manufacturer before using the product in any of the above environments or under any of the above conditions.

2. Storage

Store in manufacturer's package or tightly re-closed box with the following conditions. Use this product within 6 months after receipt. Check the terminal solderability before use if the product has been stored for more than 6 months.
Temperature: -10 to +40 degree C
Humidity: 15 to 85% RH

Notice

■ Notice (Soldering and Mounting)

1. Reflow soldering

Soldering must be carried out without exceeding the allowable soldering temperature and time shown within the shaded area of Figure "Allowable Temperature and Time of Reflow Soldering".

In case the soldering is repeated, the maximum time in Figure "Allowable Temperature and Time of Reflow Soldering" should be accumulated time. The standard soldering conditions are shown in Figure "Reflow Soldering Standard Conditions".

Follow recommended solder stencil mask pattern to avoid the possibility of solder being trapped under connector.

2. Soldering by soldering iron

Soldering by soldering iron should be carried out in accordance to the following conditions.

Pre-heating	Temperature	150°C
	Time	60 to 120 s.
Soldering	Temperature (at the tip of the soldering iron) less than 350°C	
	Time	less than 3 s.

3. We cannot warrant against mishaps caused by any use of this product that deviates from allowable temperature and time of reflow soldering.

4. In soldering, do not apply excessive mechanical force to terminals or leads greater than specified in the drawing.

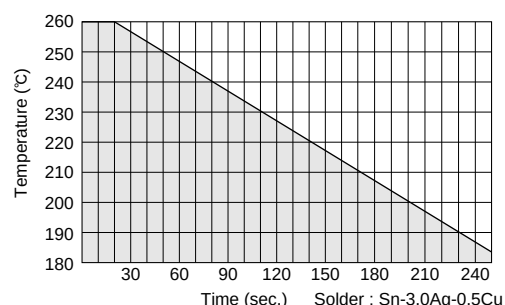
5. Please note the following in case of soldering terminals or leads of the product.

- (1) Use Rosin based flux, but not with strong acid flux (Chlorine content should be less than 0.20wt%).
- (2) Flux should be thoroughly cleaned from connector to prevent possible deterioration of electrical characteristics.

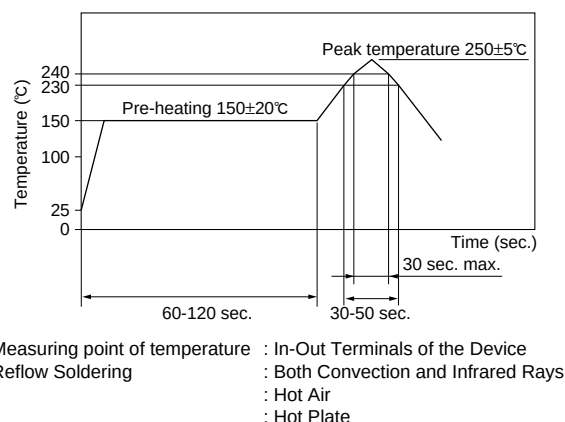
6. Please mount this product at the position so that stress by wrap and/or bend of the PCB may not apply to it.

7. Please dry out this product immediately after soldering and cleaning.

Allowable Temperature and Time of Reflow Soldering



Reflow Soldering Standard Conditions



Continued on the following page. ↗

Notice

Continued from the preceding page.

■ Notice (Handling)

1. Usage Condition

- (1) Do not apply electrical voltage greater than specified in the drawing. It might cause degradation or destruction of the product. Even if it endures during a short time, long time qualification is not guaranteed.
- (2) Confirm product's performance is not influenced by contact of other components.
- (3) Please contact the manufacturer beforehand, if the product is to be used in frequently bent position.

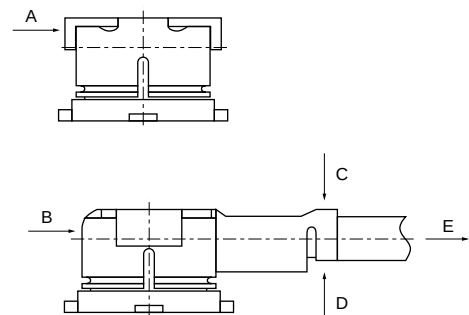
2. Handling

- (1) Avoid excessive stress when handling and transporting printed circuit board after connector and/or assembly has been secured to PCB.
- (2) Do not try to pull the cable, when a connector with a coaxial cable is handled.
- (3) Disregarding the following notes could cause mechanical damage and/or poor electrical performance.

3. Handling Instructions

- (1) Cable is designed to fit only with MM9329-2700 receptacle. Any other receptacle cannot be used with this cable.
- (2) Disengagement:
Use tool P/N M22001 to insert or remove cable in a vertical direction from receptacle. Avoid pulling only the cable to prevent cable damage.
- (3) Avoid twisting probe or cable when engaging or disengaging from connector.
- (4) Mechanical stress:
The stress to the connector should be limited as shown in Figure 1.
 - (a) Stress to the housing.
Stress A and B: 5.0N max.
 - (b) Stress to the outer sleeve.
 - Stress C: 3.0N max.
 - Stress D: 2.0N max.
 - (c) Cable pull strength.
Stress E: 5.0N max.

Figure 1. Mechanical Stress after Engagement



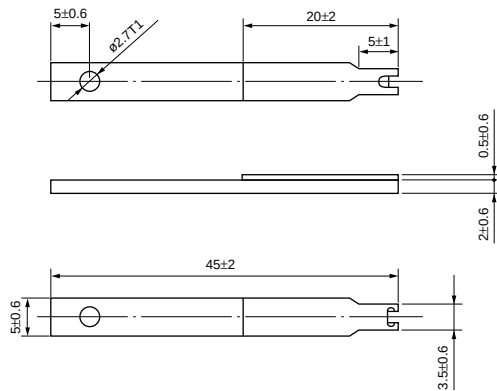
muRata

29

 Continued from the preceding page.

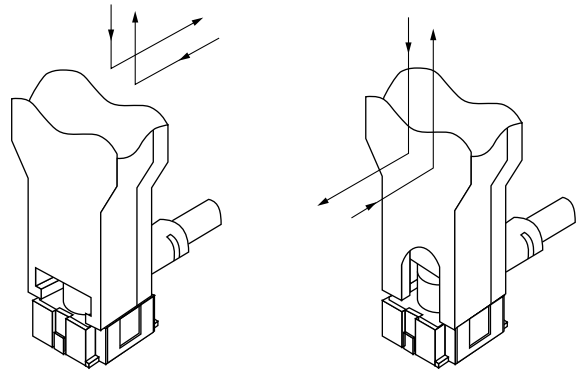
■ Disengagement Tool

M19000 (for MM7329-2700)

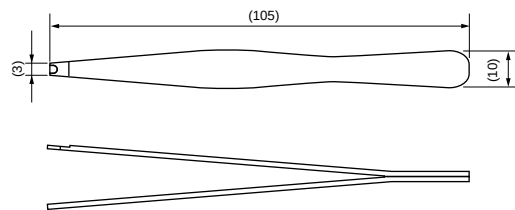


(in mm)

How to use tool (for MM7329-2700)

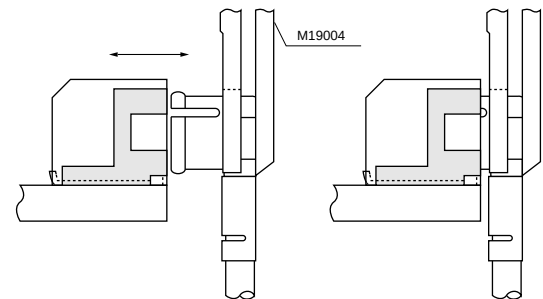


M19004 (for MM7329-2702)



(in mm)

How to use tool (for MM7329-2702)



Notice

■ Notice (Storage and Operating Condition)

1. Environment Conditions

- (1) This product is designed for use in electrical equipment in the environment (temperature, humidity, atmospheric pressure, etc.) specified in this approval drawing. It may not be used in the following environments or under the following conditions:
- (a) Ambient air containing corrosive gas (Chlorine gas, Hydrogen sulfide gas, Ammonia gas, Sulfuric acid gas, Nitric oxide gas, etc.)
 - (b) Ambient air containing volatile or combustible gas
 - (c) In liquid (water, oil, chemical solution, organic solvents, etc.)
 - (d) In environments with a high concentration of airborne particles
 - (e) In direct sunlight
 - (f) Dusty conditions
 - (g) In freezing
 - (h) Other environments similar to the above conditions
- (2) Contact the manufacturer before using the product in any of the above environments or under any of the above conditions.

2. Storage

Store in manufacturer's package or tightly re-closed box with the following conditions. Use this product within 6 months after receipt. Check the terminal solderability before use if the product has been stored for more than 6 months.

Temperature: -10 to +40 degree C
Humidity: 15 to 85% RH

Notice

■ Notice (Soldering and Mounting)

1. Reflow soldering

Soldering must be carried out without exceeding the allowable soldering temperature and time shown within the shaded area of Figure "Allowable Temperature and Time of Reflow Soldering".

In case the soldering is repeated, the maximum time in Figure "Allowable Temperature and Time of Reflow Soldering" should be accumulated time. The standard soldering conditions are shown in Figure "Reflow Soldering Standard Conditions".

Follow Standard pattern dimensions.

2. Soldering by soldering iron

Soldering by soldering iron should be carried out in accordance to the following conditions.

Pre-heating	Temperature	150°C
	Time	60 to 120 s.
Soldering	Temperature (at the tip of the soldering iron)	less than 350°C
	Time	less than 3 s.

3. We cannot warrant against mishaps caused by any use of this product that deviates from allowable temperature and time of reflow soldering.

4. In soldering, do not apply excessive mechanical force to terminals or leads greater than specified in the drawing.

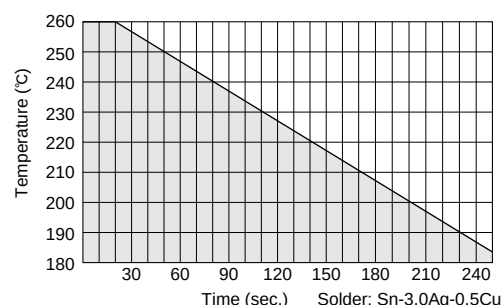
5. Please note the following in case of soldering terminals or leads of the product.

- (1) Use Rosin based flux, but not with strong acid flux (Chlorine content should be less than 0.20wt%).
- (2) Flux should be thoroughly cleaned from connector to prevent possible deterioration of electrical characteristics.

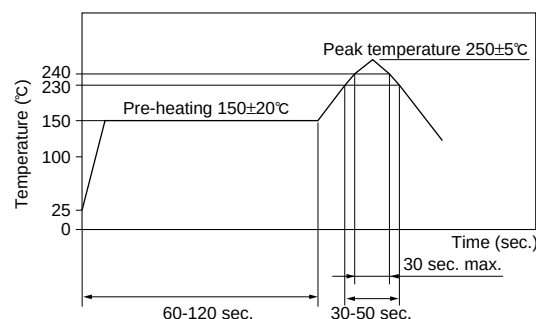
6. Please mount this product at the position so that stress by wrap and/or bend of the PCB may not apply to it.

7. Please dry out this product immediately after soldering and cleaning.

Allowable Temperature and Time of Reflow Soldering



Reflow Soldering Standard Conditions



Measuring point of temperature: In-Out Terminals of the Device
 Reflow Soldering: Both Convection and Infrared Rays
 : Hot Air
 : Hot Plate

Notice

Continued from the preceding page.

■ Notice (Handling)

1. Usage Condition

- (1) Do not apply electrical voltage greater than specified in the drawing. It might cause degradation or destruction of the product. Even if it endures during a short time, long time qualification is not guaranteed.
- (2) Confirm product's performance is not influenced by contact of other components.
- (3) Please contact the manufacturer beforehand, if the product is to be used in frequently bent position.

2. Handling

- (1) Avoid excessive stress when handling and transporting printed circuit board after connector and/or assembly has been secured to PCB.
- (2) Do not try to pull the cable, when a connector with a coaxial cable is handled.
- (3) Disregarding the following notes could cause mechanical damage and/or poor electrical performance.

3. Handling Instructions

- (1) Cable is designed to fit only with MM7329-2700 and MM7329-2702 receptacles. Any other receptacle can not be used with this cable.
- (2) Disengagement:
Use tool P/N M19000 (for MM7329-2700) or M19004 (for MM7329-2702) to insert or remove cable in a vertical direction from receptacle. Avoid pulling only the cable to prevent cable damage.
- (3) Avoid twisting probe or cable when inserting or removing from receptacle.
- (4) Mechanical stress:
The stress to the connector should be limited as shown in Figure 1.

(a) Stress to the housing.

Stress A and B: 4.9N max.

(b) Stress to the outer sleeve.

Stress C: 2.94N max.

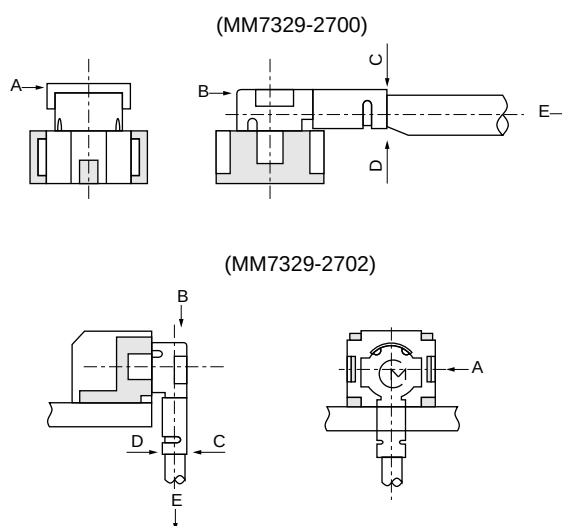
Stress D: 1.96N max.

(c) Cable pull strength.

Stress E: 7.84N max. (for MM7329-2700)

4.9N max. (for MM7329-2702)

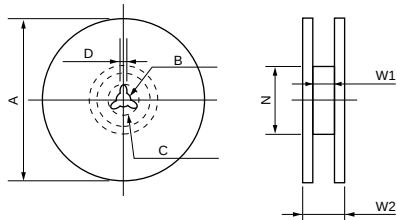
Figure 1. Mechanical Stress after Engagement



Package

■ Dimensions of Reel

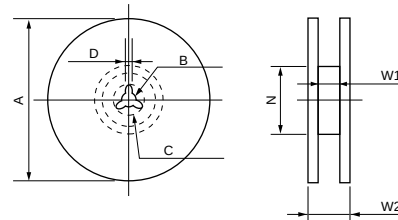
MM7329-2700RA1/RB4



(in mm)

Murata Part Number	A	B	C	D	N (min.)	W1	W2 (max.)
MM7329-2700RA1	178	13	21	2	Dia. 50	13.5	18.5
MM7329-2700RB4	330	13	21	2	Dia. 50	13.5	18.5
TOLERANCE	±2.0	±0.5	±0.8	±0.5	—	±1.5	—

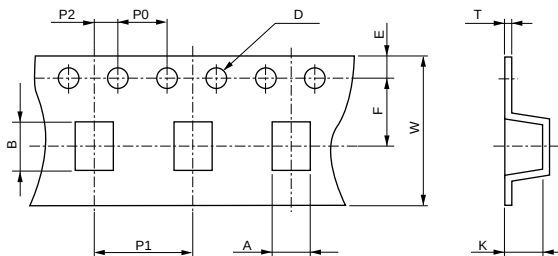
MM7329-2702RAB/RB2



(in mm)

Murata Part Number	A	B	C	D	N (min.)	W1	W2 (max.)
MM7329-2702RAB	178	13	21	2	Dia. 50	13.5	18.5
MM7329-2702RB2	330	13	21	2	Dia. 50	13.5	18.5
TOLERANCE	±2.0	±0.5	±0.8	±0.5	—	±1.5	—

■ Dimensions of Taping



A	B	W	D	E	F	K	P0
3.9±0.1	3.7±0.1	12±0.2	0.15±0.1	1.75±0.1	5.5±0.1	3±0.15	4±0.1

P1	P2	T
8±0.1	2±0.1	0.3±0.05

(in mm)

■ Minimum Quantity

MM7329-2700RA1: dia.180 mm reel/1000 pcs.

MM7329-2700RB4: dia.330 mm reel/4000 pcs.

MM7329-2700B: Bulk/free

MM7329-2702RAB: dia.180 mm reel/ 500 pcs.

MM7329-2702RB2: dia.330 mm reel/2000 pcs.

MM7329-2702B: Bulk/free

Miniaturized Microwave Coaxial Connector Cable List

			0.8D single shield FEP cable	0.4D single shield FEP cable	0.4D single shield PFA cable	0.4D single shield PFA cable	0.4D single shield PFA cable
Murata cable code			76	81	88	92	32
Inner conductor	Material	-	Silver coated copper covered steel wire	Silver coated copper wire	Silver coated copper covered steel wire	Silver coated copper wire	Silver coated copper wire
	No. and Dia.	(No./mm)	1/0.26	7/0.05	1/0.15	7/0.05	7/0.05
	Total Dia.	(mm)	0.26	0.15	0.15	0.15	0.15
Insulator	Material	-	FEP	FEP	PFA	PFA	PFA
	Melting point (Reference only)	Degree C	285	250	302-310	302-310	302-310
	Total Dia.	(mm)	0.8	0.4	0.43	0.4	0.4
Outer conductor	Material	-	Tin plated copper wire	Tin plated copper wire	Tin plated copper wire	Tin plated copper wire	Silver plated copper wire
	Dia. of wire	(mm)	0.05	0.05	0.05	0.05	0.05
	Total Dia.	(mm)	1.05	0.65	0.68	0.65	0.65
Sheath	Material	-	FEP	FEP	PFA	PFA	PFA
	Nominal thickness	(mm)	0.1	0.05	0.075	0.075	0.075
	Color	-	Gray	White	White	White	White
Overall Dia.		(mm)	1.24	0.8	0.83	0.8	0.8
Minimum bending radius		(mm)	6	4.8	3.3	3.3	3.3
Nominal impedance		(Ohm)	50	50	50	50	50
Continuous operating voltage			300 Vrms max.	300 Vrms max.	300 Vrms max.	300 Vrms max.	300 Vrms max.
Nominal static capacitance		(pF/m)	100	100	100	100	100
Nominal Insertion loss	dB/m at 1GHz		1.56	3.0	2.89	3.0	3.0
	dB/m at 2GHz		2.3	4.26	4.28	4.26	4.26
	dB/m at 3GHz		2.9	5.24	5.39	5.24	5.24
	dB/m at 4GHz		3.5	6.18	6.44	6.18	6.18
	dB/m at 6GHz				8.4	9.17	9.17
Assembly to FSC			Suitable	Suitable	Not Suitable	Not Suitable	Not Suitable
Assembly to GSC			Not Suitable	Not Suitable	Suitable	Suitable	Not Suitable
Assembly to HSC			Not Suitable	Not Suitable	Not Suitable	Not Suitable	Suitable



• This PDF catalog is downloaded from the website of Murata Manufacturing co., ltd. Therefore, it's specifications are subject to change or our products in it may be discontinued without advance notice. Please check with our sales representatives or product engineers before ordering.
 • This PDF catalog has only typical specifications because there is no space for detailed specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

Note:

1. Export Control
 〈For customers outside Japan〉
 No muRata products should be used or sold, through any channels, for use in the design, development, production, utilization, maintenance or operation of, or otherwise contribution to (1) any weapons (Weapons of Mass Destruction (nuclear, chemical or biological weapons or missiles) or conventional weapons) or (2) goods or systems specially designed or intended for military end-use or utilization by military end-users.
 〈For customers in Japan〉
 For products which are controlled items subject to the "Foreign Exchange and Foreign Trade Law" of Japan, the export license specified by the law is required for export.
2. Please contact our sales representatives or product engineers before using the products in this catalog for the applications listed below, which require especially high reliability for the prevention of defects which might directly damage a third party's life, body or property, or when one of our products is intended for use in applications other than those specified in this catalog.

① Aircraft equipment	② Aerospace equipment
③ Undersea equipment	④ Power plant equipment
⑤ Medical equipment	⑥ Transportation equipment (vehicles, trains, ships, etc.)
⑦ Traffic signal equipment	⑧ Disaster prevention / crime prevention equipment
⑨ Data-processing equipment	⑩ Application of similar complexity and/or reliability requirements to the applications listed above
3. Product specifications in this catalog are as of July 2007. They are subject to change or our products in it may be discontinued without advance notice. Please check with our sales representatives or product engineers before ordering. If there are any questions, please contact our sales representatives or product engineers.
4. Please read rating and CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
5. This catalog has only typical specifications because there is no space for detailed specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.
6. Please note that unless otherwise specified, we shall assume no responsibility whatsoever for any conflict or dispute that may occur in connection with the effect of our and/or a third party's intellectual property rights and other related rights in consideration of your use of our products and/or information described or contained in our catalogs. In this connection, no representation shall be made to the effect that any third parties are authorized to use the rights mentioned above under licenses without our consent.
7. No ozone depleting substances (ODS) under the Montreal Protocol are used in our manufacturing process.



Murata Manufacturing Co., Ltd.

<http://www.murata.com/>

Head Office

1-10-1, Higashi Kotari, Nagaokakyo-shi, Kyoto 617-8555, Japan
 Phone: 81-75-951-9111

International Division

3-29-12, Shibuya, Shibuya-ku, Tokyo 150-0002, Japan
 Phone: 81-3-5469-6123 Fax: 81-3-5469-6155 E-mail: intl@murata.co.jp